

NDIA

2017 Fuze Conference

Celebrating 60 Years of Fuzing Excellence



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**May 9-11, 2017
Westin Cincinnati, Cincinnati, OH**

Schedule

TUESDAY, MAY 9TH

3:00 PM - 4:30 PM Table Top Display Set Up - *Gibson Foyer*

4:30 PM - 6:00 PM Registration and Opening Reception - *Gibson Foyer*

WEDNESDAY, MAY 10TH

7:00 AM - 8:00 AM Registration and Continental Breakfast - *Gibson Foyer*
Session I - Welcome, Administrative & Keynote Address - *Presidential Ballroom I-II*

8:00 AM - 8:05 AM Introduction & Administrative Announcements
Mr. Bob Hertlein, L-3 Fuzing and Ordnance Systems, NDIA Fuze Committee Chair

8:05 AM - 8:15 AM NDIA Opening Remarks
Mr. Frank Michael, *SVP, Program Development*, National Defense Industrial Association

8:15 AM - 8:45 AM Keynote Address
Dr. Yvette Weber, *Air Force Deputy Program Executive Officer for Weapons*, Armament Directorate

Session II - U.S. Government Science, Technology & Acquisition
Session Chair: Mr. Ed Cooper
Session Assistant: Mr. Bob Hertlein

8:45 AM - 9:10 AM Army S&T Strategy
Mr. Thomas Crowley, *Chief, Munitions Fuzing Branch*, US Army ARDEC
Mr. Rick Kulbacki, *Electronics Engineer*, US Army RDECOM AMRDEC

9:10 AM - 9:30 AM Navy S&T Strategy
Dr. Michael Deeds, *Fuze and Initiation Systems Branch Manager*, NSWC IHEODTD

9:30 AM - 10:00 AM Air Force S&T Strategy
Mr. George Jolly, *Technical Advisor*, Air Force Research Laboratory

10:00 AM - 10:30 AM Morning Break - *Gibson Foyer*

10:30 AM - 11:00 AM OSD Perspective/Fuze IPT
Mr. Lawrence Fan, *JFTP Manager*, NSWC IHEODTD

11:00 AM - 11:30 AM Joint Fuze Technology Program (JFTP)
Mr. Lawrence Fan, *JFTP Manager*, NSWC IHEODTD

11:30 AM - 11:50 AM International Collaboration in Fuze R&D: Opportunities and Perspectives
Dr. Jason Foley, *International Program Officer*, European Office of Aerospace R&D

11:50 AM - 12:00 PM Harry Diamond Fuzing Award Ceremony

12:00 PM - 1:00 PM Lunch - *Fountain Room*

Please note that the Closed Sessions are for U.S. Citizens Only. You must check-in at the Security Certification table to obtain the daily colored wrist band.

1:00 PM – 3:00 PM

Concurrent Sessions:

SESSION		1:00 PM	1:20 PM	1:40 PM	2:00 PM	2:20 PM	2:40 PM
SESSION IIIA Session Chairs: Nassir Alaboud & Ed Cooper	OPEN SESSION	19238 - Digital Device Architecture and the Safe Use of Flash Devices in Munitions Mr. Richard Katz, NASA	19239 - Environmental Effects on Data Retention in Flash Cells Mr. Richard Katz, NASA	19279 - Challenges of using Logic Devices in the Implementation of Safety Features for Fuzing Systems Mr. Stefan Ebenhoech, Fraunhofer Ernst Mach Inst.	19273 - Use of Multi-core Processor Technology in Fuzing Systems Mr. Jeffrey Fornoff, US Army ARDEC	20000 - Precision Munition and Fuze Initiatives Mr. Gregory Bischer, US Army, Guided Precision Munitions and Mortar Systems	19340 - Conventional Fuze Improvements Mr. Keith Amadio, US Army ARDEC
SESSION IIIB Session Chairs: Thomas Harward & Doug Harms	CLOSED SESSION	19379 - UK Miniaturised, Hard Target Fuze Research Mr. Laurie Turner, Thales	19376 - Dual Mode Lidar/Radar TDD TRL5 UK Technology Demonstration Program Mr. Gary Buzzard, Thales	19196 - Virtically Integrating Switching Technology Progress & Test Results Mr. Brad Hanna, NSWDC Dahlgren	19363 - Joint Fuze Technology's Next Generation Proximity Sensors Mr. Evan Young, US Army ARDEC	19231 - High Reliability DPICM Replacement (HRDR) Mr. Kevin Cochran, NSWDC Indian Head	19322 - Stacked MOSFET/IGBT Pulse Discharge Switch Mr. Paul Anderson, NAWCWD China Lake

3:00 PM – 3:20 PM

Afternoon Break – Gibson Foyer

3:20 PM – 5:20 PM

Concurrent Sessions:

SESSION		3:20 PM	3:40 PM	4:00 PM	4:20 PM	4:40 PM	5:00 PM
SESSION IIIA Session Chairs: Nassir Alaboud & Ed Cooper	OPEN SESSION	19380 - New Modular Integrated Electronic Safe & Arm Device Development for a US Army Anti-Armour Weapon Mr. Laurie Turner, Thales	19287 - Next Generation 40mm IG Fuzes Mr. Florian Kunz, Junghans Defence	19374 - New Lidar/Magnetic TDD Development for a US Army Anti Armour Weapon Mr. Gary Buzzard, Thales	19368 - Shock Testing of 3D Printed Multi-material Circuits Dr. Amanda Schrand, AFRL	19191 - Influence of the Embedded Position for Damages and Reactive Threshold Induced by Concrete Penetration Mr. Alexandre Lefrancois, Centre de Gramat	
SESSION IIIB Session Chairs: Thomas Harward & Doug Harms	CLOSED SESSION	19202 - DPICM-XL High Reliability Fuzing Mr. Craig Doremus, US Army ARDEC	19311 - Advance Multi-Purpose (AMP) Tank Fuzing Solution Mr. James Ring, Orbital ATK	19224 - Advancements in Common ESADs Mr. Joe Carda, Orbital ATK	19318 - Proposed Fuze Safety Qualification Procedures for Distributed Embedded Fuzing Systems Dr. Janet Wolfson, AFRL	19303 - Mechanical Testing of Embedded Fuze Designs Mr. Curtis McKinion, AFRL	19266 - Imaging Fuze Experimentation for Weapon Terminal Burstpoint Control Dr. Matthew Burfeindt, AFRL

5:20 PM

Adjourn

5:30 PM – 7:00 PM

Grand Reception – Fountain Room

THURSDAY, MAY 11TH

7:00 AM – 8:00 AM

Registration and Continental Breakfast – Gibson Foyer

8:00 AM – 12:00 PM

Concurrent Sessions:

SESSION		8:00 AM	8:20 AM	8:40 AM	9:00 AM	9:20 AM	9:40 AM
SESSION IVA Session Chairs: Roy Streetz & Mark Etheridge	OPEN SESSION	19459 - ESAD Design for Modular Missile Technology Mr. Wayne Eads, Dynetics Inc	19300 - Modern Fuze Developments & Concepts Mr. Robert Huettner, Rheinmetall Defence	19278 - Spectrum of Modern Fuze Batteries Mr. Matthias Franz, Diehl & Eagle-Picher	19205 - The Power of the Fuze Mr. Harald Wich, Diehl & Eagle-Picher	19335 - Test Bench for Activatable Batteries Mr. Sebastian Hess, EMI Fraunhofer	
SESSION IVB Session Chairs: Eric Roach & Don Shutt	CLOSED SESSION	19337 - Low-Cost, Low-Energy EFIs Using Commercial Materials and Processes Mr. Michael Ward, Electronics Development Corporation	19347 - Hard Target Detonator Research Using Binderized RSI-007 and Alternate Microchip Mr. Emmanuel Morales, Reynolds Systems	19354 - Computational Modeling of Exploding Foil Initiators (EFIs) Mr. Ed Wild, AFRL	19312 - Hardened Selectable Multipoint Fuzing Mr. Michael Connolly, US Army RDECOM AMRDEC	19305 - Using Modeled Impact Response of 3-D Printed Materials for High-G Survivability Mr. Ezra Chen, NSWDC Indian Head	19320 - Advanced Analysis Techniques for the Implementation of Flash Devices In Safety-Critical Applications Mr. David Flowers, Defense Microelectronics Activity

Schedule

10:00 AM - 10:20

Morning Break - *Gibson Foyer*

SESSION		10:20 AM	10:40 AM	11:00 AM	11:20 AM	11:40 AM
SESSION IVA Session Chairs: Roy Streetz & Mark Etheridge	OPEN SESSION	19359 - Dynamic Initiator Imaging at the Advanced Photon Source: Understanding the Early Stages of Initiator Function and Subsequent Explosive Interactions Dr. Nate Sanchez, Los Alamos National Laboratories	19502 - Development of Environmentally Benign Pyrotechnic Delays Dr. Jay Poret, US Army RDECOM-ARDEC	19284 - Insensitive Electric Priming And Fusing Ignition Method Using Aluminum Nitride/Tungsten Trace Heaters Mr. Howard Kent, Armor Development Group, LLC	19252 - DBX-1 - Green Primary Explosive Related Efforts Mr. Steve Marino, Action Manufacturing Company	
SESSION IVB Session Chairs: Eric Roach & Don Shutt	CLOSED SESSION	19246 - Precision Height-of-Burst Proximity Sensor Field Test Results Ms. Amanda Skuza, L-3 Mustang	19228 - Dynamic Target Model Simulation Enhancements for Advanced Fuze Processor Development Mr. Charles H Overman IV, University of Florida	19267 - Fast Synthetic Scene Generation for Fuze Sensor Development Dr. Matthew Burfeindt, AFRL	19259 - FMU-160A/B Proximity Fuze Mr. Keith Amadio/ Mr. Scott Colegrove, US Army ARDEC	19314 - Wireless Power Transmission for Remote Fuzing Applications Mr. Thomas Hartmann, Sandia National Laboratories

12:00 PM - 1:00 PM

Lunch - *Fountain Room*

1:00 PM - 5:20 PM

Concurrent Sessions:

SESSION		1:00 PM	1:20 PM	1:40 PM	2:00 PM	2:20 PM	2:40 PM
SESSION VA Session Chairs: Bob Hertlein & Byron Lee	OPEN SESSION	19317 - Fuze Modeling Grand Challenge: Computational Comparisons Round 3 Dr. Janet Wolfson, AFRL	19206 - Higher-Order Finite-Element Analysis for Fuzes Subjected to High-Frequency Environments Dr. Stephen Beissel, Southwest Research Institute	19280 - Explicit Dynamics based System Simulation of Hardened Fuzing Systems Dr. Raphael Gutser, TDW GmbH	19308 - Modeling and Simulation of a High Fidelity Electronics Assembly Responding to Drop Test Mr. Miroslav Tesla, US Army ARDEC	19501 - Integration of Fire Set Structures using Additive Manufacturing Mr. Daniel Pitts, US Army AMRDEC	19315 - DoD MEMS Fuze Explosive Train Evaluation & Enhancement Mr. Taylor Young, NSWC Indian Head
SESSION VB Session Chairs: Bruce Hornberger & Frank Fairchild	CLOSED SESSION	19321 - Energy Harvesting and Event Detection for Electronic Safe Arm Fuzing (ESAF) in Gravity Dropped Weapons Mr. Paul Anderson, NAWCWD China Lake	19203 - On-Board Power Generation for a 66mm Shoulder Fired System Mr. Chris Savarese, Nammo Talley	19281 - Testing Philosophy for Distributed Fuzing Applications Mr. Chuck Treu, DOE National Security Campus	19227 - Fuze Setting Technologies for Rockets & Missiles Mr. Mark Etheridge, US Army AMRDEC	19328 - Mechanical Survivability of Embedded Fireset in Quasi-Static and Dynamic High-Pressure Environment Lt Cole Piper, AFRL	19386 - Advanced Optical Fuze Programmer Mr. Michael Strauss, Creative Microsystems

3:00 PM - 3:20 PM

Afternoon Break - *Gibson Foyer*

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SESSION VA Session Chairs: Bob Hertlein & Byron Lee	OPEN SESSION	19390 - Wireless Data Recording Mr. Perry Salyers, L-3 FOS	19307 - Fatigue and High Strain Rate Behavior of SAC305 Solder Dr. Vasant Joshi, NSWC Indian Head				
SESSION VB Session Chairs: Bruce Hornberger & Frank Fairchild	CLOSED SESSION	19352 - Embedded Precision Initiation for Next-generation Engagements (PINE) Fireset R&D for General Purpose Warhead Applications Mr. John Bailey, AFRL	19358 - Developing Additive Manufacturing Process Parameters for Fuze Applications Ms. Leila Zunino, US Army ARDEC	19245 - Integrated Inertia Switches for Fuzing Applications Dr. Todd Christenson, HT Micro	19346 - Design Challenges and Considerations for Embedded Fuzing Mr. Brent Francis, L-3 FOS	19178 - Down Range Drag Correction for Medium Caliber Munitions Mr. Andrew Surowiec, US Army ARDEC	19371 - Parametric Determination of a Fireset's Ability to Reliably Fire an Exploding Foil Initiated Detonator Dr. Glen Kading, Excelitas Technologies

5:20 PM

Conference Adjourn

TABLE TOP DISPLAY INFORMATION

DISPLAYING COMPANIES

Diehl & Eagle Picher GmbH

EnerSys

Excelitas Technologies Corp.

Gowanda Electronics

HT MicroAnalytical, Inc.

Knowles–Novacap

Meggitt Sensing Systems

NASCENTechnology Manufacturing, Inc..

PCB Piezotronics, Inc.

Presidio Components, Inc.

Teledyne e2v

Vanguard Electronics

Workers Explosives Safety Training, Inc. (WEST)

DISPLAY HOURS

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3:20 PM – 5:00 PM Table Display Dismantle

Attendee Roster as of 5-1-2017

Awad Aalnuaimi
UAE Armed Forces

John Aasen
Kongsberg Defence Systems

Abdulnassir Alaboud
Lockheed Martin Missiles and Fire Control

Karen Amabile
U.S. Army ARDEC

Keith Amadio
US Army ARDEC

Hans Petter Andersson
Kongsberg Defence Systems

Thomas Yong Lim Ang
Advanced Material Engineering Pte Ltd

Thomas Anthony
EnerSys

Tabitha Apple
Naval Surface Warfare Center Dahlgren

Carmelo Aresco
Kaman Precision Products

Marius Bakken
Kongsberg Defence Systems

Antonio Barreiro
SFAE-AMO-CAS

William Bartinelli
L3 Fuzing & Ordnance Systems

Carsten Becker
JUNGHANS Defence

Elizabeth Becker
Fourth Factor Engineering, LLC

Stephen Beissel
Southwest Research Institute

Douglas Benner
Excelitas Technologies

Steven Benulis
EnerSys

Anne Benz
Sandia National Laboratories

Cagin Bingol
TUBITAK SAGE

Greg Bischer
Department of the Army

William Black
Lockheed Martin Missiles and Fire Control

T. Gaynor Blake
Hanley Industries, Inc.

Francis Blodgett
Alinabal, Inc.

Timothy Bonbrake
L3 Fuzing & Ordnance Systems

Carl Boss
Garrity Tool Company, Inc.

Ted Bucher
Saab Bofors Test Center AB

Chris Bulian
AMTEC Corporation

Matthew Burfeindt
Air Force Research Laboratory

Gary Buzzard
Thales Missile Electronics

Joseph Carda
Orbital ATK

Michael Carlsson
Saab Bofors Dynamics AB

Jose Carpintero
NSWC IHD Det. Picatinny

Joseph Carvalho
Pacific Scientific

Gökmen CENGİZ
ASELSAN A.S.

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L3 Mustang Technology

Todd Christenson
HT MicroAnalytical, Inc.

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Defence Science and Technology Laboratory
(DSTL)

Jonathon Clark
U.S. Army Aviation and Missile Research, Develop-
ment and Engineering Center

Olivier Clesca
Thales Nederland BV

Norman Coker
AFLCMC/EBDZ

Scott Colegrove
L3 Fuzing & Ordnance Systems

Raymond Colon
PM Combat Ammunition Systems

Michael Connolly
U.S. Army AMRDEC

Edward Cooper
L3 Fuzing & Ordnance Systems

Thomas Crowley
RDECOM-ARDEC

Daniel Czaja
HT MicroAnalytical, Inc.

Chris Davis
TX Sales, Inc.

Ian Davis
Teledyne e2V

Michael Deeds
Naval Surface Warfare Center, Indian Head Explo-
sives Ordnance Disposal Technology Division

John Deep
Air Force Research Laboratory

Ron Deermer
Worker Explosives Safety Training, Inc. (WEST)

Andrew DesJardins
R & R Trucking Co.

Christopher DeWitt
Kaman Precision Products

Craig Doremus
ARMY Fuze Division

Bryan Driskell
L3 Fuzing & Ordnance Systems

Derek Duckworth
L3 Fuzing & Ordnance Systems

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NASCENTechnology, Inc.

Barry Dutt
PM-CAS

Wayne Eads
Dynamics, Inc.

Stefan Ebenhoech
Fraunhofer Ernst-Mach-Institut (EMI)

Matthew Eckel
AMTEC Corporation

Arie Elbert

Mark Etheridge
U.S. Army AMRDEC

William Evelyn
Day & Zimmermann, Inc.

Michael Faber
Rheinmetall Zaugg AG

Lawrence Fan
Naval Surface Warfare Center, Indian Head Explo-
sives Ordnance Disposal Technology Division

Brent Felton
Orbital ATK

Dave Fine
Orbital ATK

Jason Foley
EOARD (European Office of Aerospace R&D)

Jeffrey Fornoff
US Army ARDEC

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Excelitas Technologies

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Bryan Gresock
Garrity Tool Company, Inc.

Pascal Guenot
Nammo MTH SA

Ozdemir Gumusay
ASELSAN A.S.

Raphael Gutser
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Pacific Scientific Energetic Materials

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Thomas Hartmann
Sandia National Laboratories

Thomas Harward
Raytheon Company

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Danny Hayles
Booz Allen Hamilton

Milton Henderson
U.S. Army AMRDEC

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308th Armament Systems Wing

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Fraunhofer Institut EMI

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Lockheed Martin Corporation

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Saab Bofors Dynamics AB

Jared Holtman
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Hanwha Corporation

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Air Force Research Laboratory

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HONGJIP JUNG
Poongsan

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Kaman Precision Products

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Armor Development Group LLC

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Werner Knubel
RUAG Ammotec

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Jason Koonts
Naval Surface Warfare Center Dahlgren

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Kurtz Associates

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Orbital ATK

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Orbital ATK

Jeffrey Lee
Orbital ATK

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Commissariat à l'Énergie Atomique

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Pacific Scientific Energetic Materials

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Beijing Institute of Technology

Lawrence Liberman
Naval Surface Warfare Center

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U.S. Army AMRDEC

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BAE Armament Systems Division

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e2v technologies, PLC.

Jennifer MacDonell
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Rheinmetall Denel Munition

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Karagozian & Case, Inc.

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Lockheed Martin Corporation

Telemachos Manolatos
Electronics Development Corp.

Pierpaolo Marinelli
SIMMEL DIFESA SpA

Steve Marino
Action Manufacturing Company

Mark Matthews
EnerSys

Stanley Mazur
Ensign-Bickford Aerospace & Defense

Michael McAlister
46th Test Wing

Curtis McKinion
Air Force Research Laboratory

Robert Metz
PCB Piezotronics

James Mickolajczyk
NSWC IHD Det. Picatinny

Francis Milbower
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Don Minnick
Gowanda Electronics

Mark Mishler
L3 Fuzing & Ordnance Systems

Anthony Mittas
Dynamic Systems and Research

Emmanuel Morales
Reynolds Systems, Inc.

Michael Naim
Statek Corporation

Christopher Nance
Reynolds Systems, Inc.

Attendee Roster as of 5-1-2017

Bob Nelson
Novacap, Inc.

Barry Neyer
Excelitas Technologies

Thomas Nickolin

Oscar Nilsson
Saab Bofors Dynamics AB

Thomas Noble
General Dynamics OTS

Peter Noe
Rheinmetall AG

Arthur Norton
JUNGHANS DEFENCE GmbH

Ohad Nuriel
Rafael Advanced Defense Systems Ltd.

Bob Nyulassy
Knowles

Patrick O'Malley
Sandia National Laboratories

David Ort
PCB Piezotronics

Larry Ostendorf
Pacific Scientific Energetic Materials

Maurice Oud
Ministry of Defence

Charles Overman
University of Florida/Electronic Communications Lab

Ozgur Ozfidan
ARTRON

Daniel Peairs
L3 Fuzing & Ordnance Systems

Max Perrin
JUNGHANS Defence

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Piper Pacific International

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NSWC DD

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Kaman Precision Products

Zachary Reser
Excelitas Technologies

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Orbital ATK

James Ring
Orbital ATK

Eric Roach
Lockheed Martin Missiles and Fire Control

Sam Rogers
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Stan Ross
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Henry Schoonhoven
MoD/Directorate of Logistic Agencies/Weapons & Munitions Test Department

Amanda Schrand
Air Force Research Laboratory

Christopher Schuyler
Excelitas Technologies

James Sharp
Naval Surface Warfare Center Dahlgren

Donald Shutt
Orbital ATK

David Simmons
Practical Energetics Research, LLC.

Roger Sitara
Government, Picatinny Arsenal

Amanda Skuza
L3 Mustang Technology

Zachary Spears
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Vito Spinelli
Kaman Precision Products

Danny Stahl
Hanley Industries, Inc.

Wayne Steege
Orbital ATK

Alan Stillwell
Meggitt

Arnaud Stock
MECAR SA

Monica Stoka
EnerSys

Roy Streetz
Excelitas Technologies

Matthew Stubbs
Dynetics, Inc.

Andrew Surowiec
U.S. Army ARDEC

Miroslav Tesla
U.S. Army ARDEC

Keith Thomas
Los Alamos National Laboratory

Pamela Tran
Action Manufacturing Company

Charles Treu
DoE/NNSA National Secure Manufacturing Center

Michael Triviski
BAE Systems Platforms

Laurie Turner
Thales Missile Electronics

Joe Uzarski
PCB Piezotronics

Raymond van Dijk
TNO

Robert Venino
Statek Corporation

Arno Von der Fecht
TDW GmbH

Brent Vorst
Kinetic Vision

Michael Ward
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Roketsan Missile Industries, Inc.

Mehmet Yildirim
Artron

Evan Young
US ARMY - RDECOM ARDEC Fuze Division

Leila Zunino
US Army ARDEC



For over 60 years, L3 Fuzing & Ordnance Systems (L3 FOS) has been a leader in the fuzing industry, specializing in the design, development, testing, and manufacture of Electronic Safety and Arming Fuzes, Ignition Safety Devices, Flight Termination Safe & Arm devices, and Proximity Sensors. Our products are utilized in Mortars, Artillery, Air-Dropped Bombs, Rockets, and Missiles.

Fuzing & Ordnance Systems

Located near Cincinnati, Ohio, L3 FOS' modern facility was specifically designed for the manufacture of fuzing and ordnance systems for the Department of Defense (DOD) and Missile Defense Agency (MDA). All activities, including design, engineering, production and quality, are performed at this single location, enabling process efficiencies and ensuring adherence to programmatic and technical standards. L3 FOS is dedicated to continuous improvement and operates a quality management system that is certified to AS9100C and ISO 9001:2008. Our highly flexible manufacturing operations can accommodate a variety of fuzing products, with run rates of 40,000 units per month down to individual production units for development efforts. Additionally, L3 FOS has a complete, on-site test lab to perform all required environmental test procedures.

L3 FOS also operates an advanced Automated Electronics Assembly area that produces high-reliability Flex Circuit Assemblies and Circuit Card Assemblies on modern Surface Mount Technology (SMT) equipment. This capability is on-site to control and support the most stringent quality standards for the production of military standard, safety-critical components.

At L3 FOS, customer focus is a key element of who we are and how we operate. Our customers are the foundation of our success, so we work to establish long-term relationships and ensure collaboration throughout the entire process, from concept through sustainment.

L3 FOS is committed to supporting the warfighter by providing highly reliable fuzes, safety and arming devices, proximity sensors and related products. We will continue to innovate and develop unique solutions by leveraging our valued workforce. To learn more, please visit our website www.L3T.com/FOS or call 513-943-2000.



Orbital ATK's Missile Products Division is an industry-leading developer and manufacturer of defense and aerospace components and systems. Among our extensive portfolio of highly engineered products are some of the most technologically advanced intelligent fuzes available today, including the FMU 167/B Hard Target Void Sensing Fuze and the FMU-139 D/B.

The FMU 167/B, now approved for export, offers unprecedented capability against complex hard and deeply buried targets while the first all-electronic general purpose bomb fuze, the FMU-139D/B, improves munitions' functionality with an easy, drop-in replacement to the legacy FMU-139C/B.

For more information about these and other fuzes offered by Orbital ATK, visit us at www.OrbitalATK.com and then click on Defense Systems, Missile Products.



Founded in 1980, Presidio Components is a US manufacturer specializing in high reliability pulse energy capacitors for Exploding Foil Initiator (EFI) detonators with single or multiple pulse firing operations. Available for high temperature applications (250°C+), Presidio's EFI capacitors are rated 10V to 10KVA in multiple dielectrics (X7R, N2T, NPO). As an added safety feature, capacitors can be ordered with bleed resistors that operate up to 250°C. Lead frames are available for board flex compliance, as well as stacked capacitors for increased energy density. Energy output is designed to customer specifications.

In addition to defense, Presidio supplies ceramic capacitors used in other high quality commercial, military, and space applications. Presidio's power products include low inductance chips SMD (0201 to 2225), high reliability SMPS stacks (180°C µF+), and high voltage radial leads (6000V+).

Presidio's RF Power and RF /Microwave product group features Ultra-Porcelain™ capacitors with ultra-low ESR and ultra-high Q, broadband DC blocking capacitors, as well as the smallest wire-bondable single layer and broadband bypass capacitors available. All popular case sizes are available, in both RoHS and non-RoHS versions.

Presidio is qualified to most MIL specs including the highest established reliability rating of 'S' Level for MIL-PRF-55681, and two additional space level specifications, MIL-PRF-123 and MIL-PRF-49467 'T' level. Presidio is proud to be the first QPL supplier to MIL-PRF-49467, the high voltage ceramic capacitor specification. All QPL testing per MIL-STD-202 is done on site in Presidio's DSCC approved test lab. For more information visit Presidio's website at: www.presidiocomponents.com or call (858) 578-9390.

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Fuzing & Ordnance Systems

OPENING RECEPTION SPONSOR



WEDNESDAY LUNCH SPONSOR



THURSDAY LUNCH SPONSOR

KAMAN

Fuzing & Precision Products

AGENDA SPONSOR

